

# **JL7003A Datasheet**

**Zhuhai Jieli Technology Co.,LTD**

**Version: 1.1**

**Date: 2022.07.13**

**Copyright © Zhuhai Jieli Technology Co.,LTD. All rights reserved.**

# JL7003A Features

## CPU

- 32bit Dual-Issue DSP
- Up to 160MHz programmable processor
- With IEEE754 Single precision FPU
- With cordic accelerate engine
- Advanced debug with 8 hardware breakpoints/watchpoints
- Advanced system exception capture unit

## Interrupt

- Support for up to 64 interrupts with 8 priority level
- NMI supported
- SWI supported, with configurable priority
- Low power wake up by polling pending 8 IO interrupts for low power wake up

## DSP Audio Processing

- SBC, AAC Audio decodes supported for BT audio
- mSBC voice codec supported for BT phone
- Supports MP2, MP3, WMA, APE, FLAC, AAC, MP4, M4A, WAV, AIF, AIFC audio decoding
- Packet Loss Concealment (PLC) for voice processing
- Single/Dual MIC Environmental Noise Cancellation (ENC)
- Multi-band DRC limiter
- 20-band EQ configuration for voice Effects

## Audio Codec

- Two channels 24-bit DAC, SNR  $\geq$  102dB
- Two channels 24-bit ADC, SNR  $\geq$  95dB
- DAC Sampling rates of 8kHz/11.025kHz/16kHz/22.05kHz/24kHz/32kHz/44.1kHz/48kHz/64kHz/88.2kHz/96kHz are supported
- ADC Sampling rates of 8kHz/11.025kHz/16kHz/22.05kHz/24kHz/32kHz/44.1kHz/48kHz are supported

- One analog MIC amplifier, build-in MIC bias generator
- Supports cap-less, single-ended, and One differential mode at the DAC path
- Supports 16ohm and 32ohm Speaker loading

## ANC

- ANC processing engine up to 750 kHz sample rate
- 7.5 $\mu$ s analog to analog latency
- Supports 4 digital microphone inputs, 1 differential analog inputs for ANC
- Supports Feed-Forward/Feed-Back ANC
- ANC module include 20 double precision Biquad filters for each FF/FB/ music compensation control

## Bluetooth

- Compliant with Bluetooth V5.3+BR+EDR+BLE specification
- Meet class2 and class3 transmitting power requirement
- Support GFSK and DQPSK all packet types
- Provides maximum +10dbm transmitting power
- EDR receiver with minimum -94dBm sensitivity
- Fast AGC for enhanced dynamic range
- Supports a2dp\avctp\avdtp\avrcp\hfp\spp\smp\att\gap\gatt\rfcomm\sdp\l2cap profile a2dp 1.3.2\avctp 1.4\avdtp 1.3\ avrcp 1.6.2\ hfp 1.8 \spp 1.2\rfcomm 1.1\pnp 1.3\ hid 1.1.1\sdp core5.3\l2cap core 5.3

## Peripherals

- One full speed USB 2.0 OTG controller
- Six multi-function 32-bit timers, support capture and PWM mode
- Three full-duplex basic UART, UART0, UART1 support DMA mode

- One hardware IIC interface supports host and device mode
- Two Built-in low power Cap Sense Keys
- LED controller, support 2LED control by one IO
- 10-bit ADC for analog sampling
- External wake up/interrupt on all GPIOs
- Crossbar IO support: timer\SPI\SDC\IIC\UART\RDEC\ALINK\PLINK

### PMU

- Low voltage LDO and DC-DC for internal digital and analog circuit supply
- Soft-off mode current:  
Build-in LP\_Touch off:  $\leq 2\mu\text{A}$   
Build-in LP\_Touch on:  $\leq 13\mu\text{A}$

- Built-in LDO and DC-DC for the core, I/O, Bluetooth and flash
- VBAT is 2.2V to 4.4V
- IOVDD is 2.2V to 3.6V

### Packages

- QFN20(3mm\*3mm)

### Temperature

- Operating temperature:  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$
- Storage temperature:  $-65^{\circ}\text{C}$  to  $+150^{\circ}\text{C}$

### Applications

- Bluetooth TWS Earphones
- Bluetooth TWS ANC Earphones

### Confidential

The information contained herein is the exclusive property of JIELI and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of JIELI.

# 1 Pin Definition

## 1.1 Pin Assignment

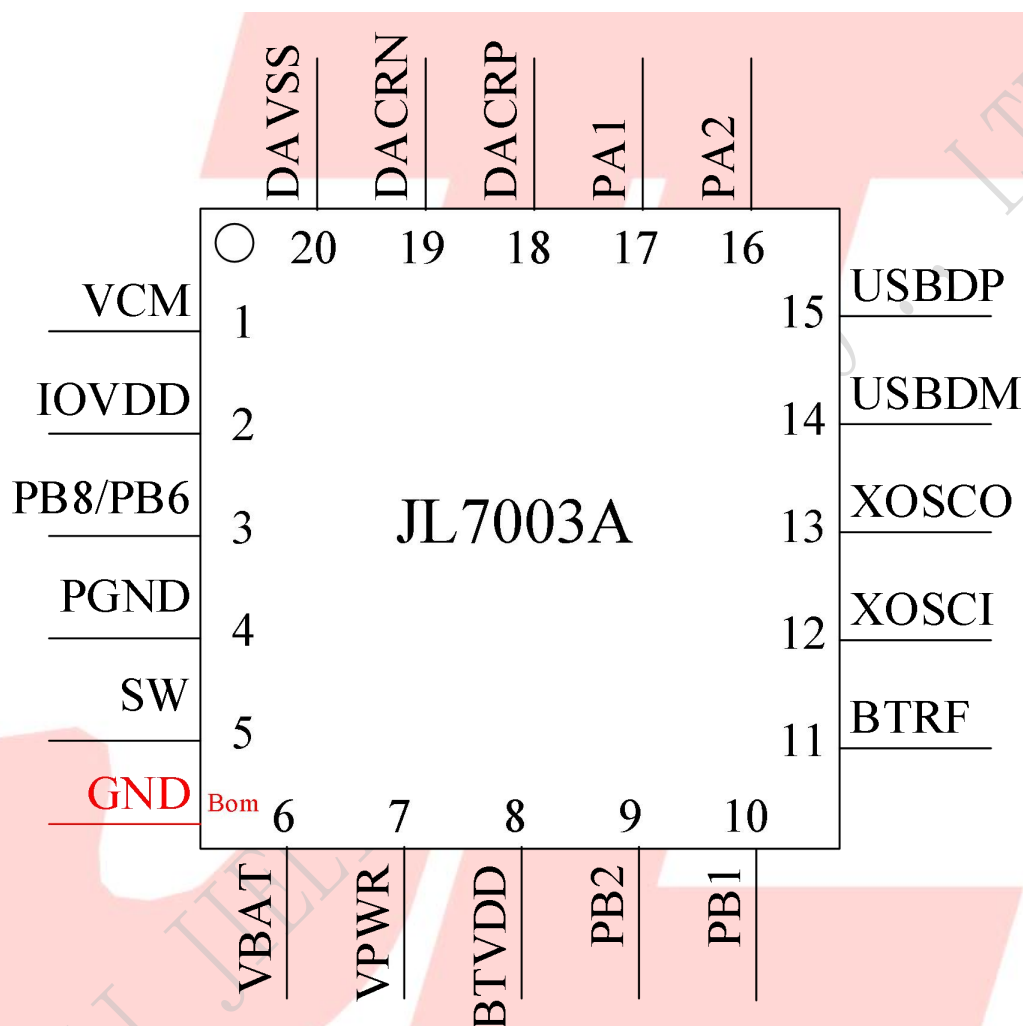


Figure 1-1 JL7003A Package Diagram

## 1.2 Pin Description

Table 1-1 JL7003A Pin Description

PIN NO.	Name	I/O Type	Drive (mA) 4 level	Function	Other Function
1	VCM	P	/		DAC reference voltage
2	IOVDD	PO	/		IO Power 3.3v
3	PB8	I/O	2.4~64	GPIO	AIN_B0; MIC1: MIC1 Input Channel; MIC1_P: Different MIC1 Positive; AMUX_B0: Analog Channel B0 L/R Input; UART0RXB: Uart0 Data Input(B); CAP4: Timer4 Capture.
	PB6	I/O	2.4~64	GPIO	ADC9: ADC Input Channel 9; UART1RXA: Uart1 Data Input(A); PWM2: Timer2 PWM Output.
4	PGND	P	/		DCDC Ground
5	SW	P	/		DCDC switch output, connected to inductor
6	VBAT	PI	/		Power Supply, connect to battery
7	VPWR	PI	/		Charge Power Input;
		I/O	8	GPIO	High Voltage Resistance I/O; UART0TXC: Uart0 Data Output(C); UART0RXC: Uart0 Data Input(C); PWM3: Timer3 PWM Output; CAP1: Timer1 Capture.
8	BTVD	PO	/	GPIO	BT Power
9	PB2	I/O	2.4~64	GPIO	LP_TH2: Low Power Touch Channel 2; ADC7: ADC Input Channel 7; CAP5: Timer5 Capture; UART2RXC: Uart2 Data Input(C); SPI2DOC: SPI2 Data Out(C).
10	PB1	I/O	2.4~64	GPIO (pull up)	Long Press Reset; LP_TH1: Low Power Touch Channel 1; UART2TXC: Uart2 Data Output(C); ADC6: ADC Input Channel 6; SPI2CLKC: SPI2 Clk(C).
11	BTRF	/	/		BT Antenna
12	XOSCI	I	/		XOSC In
13	XOSCO	O	/		XOSC Out

### Confidential

The information contained herein is the exclusive property of JIELI and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of JIELI.

14	USBDM	I/O	4	USB Negative Data	UART1RXD: Uart1 Data Input(D); IIC_SDA_A: IIC SDA(A); ADC11: ADC Input Channel 11; SPI2DOB: SPI2 Data Out(B); ISP_DI.
15	USBDP	I/O	4	USB Positive Data	UART1TXD: Uart1 Data Output(D); IIC_SCL_A: IIC SCL(A); ADC10: ADC Input Channel 10; SPI2CLKB: SPI2 Clock(B); ISP_CLK.
16	PA2	I/O	2.4~64	GPIO	AIN_A1; ALNK_MCLK(A): ALNK Master Clock(A); MIC_BIAS0: MIC0 Bias Output; MIC0_N: Different MIC0 Negative; AMUX_A1: Analog Channel A1 L/R Input; CAP3: Timer3 Capture; UART1RXC: Uart1 Data In(C); CLKOUT1.
17	PA1	I/O	2.4~64	GPIO	AIN_A0; MIC0: MIC0 Input Channel ; MIC0_P: Different MIC0 Positive; AMUX_A0: Analog Channel A0 L/R Input; PWM0: Timer0 PWM Output; UART1TXC: Uart1 Data Output(C).
18	DACRP	O	/		Different DAC Right Positive Channel
19	DACRN	O	/		Different DAC Right Negative Channel
20	DAVSS	P	/		Analog Ground
/	Bom	P	/		Ground

P: Power or Ground PO:Power Output PI:Power Input I/O:Input or Output I:Input O:Output

### Confidential

The information contained herein is the exclusive property of JIELI and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of JIELI.

## 2 Electrical Characteristics

### 2.1 Absolute Maximum Ratings

Table 2-1

Symbol	Parameter	Min	Max	Unit
T <sub>opt</sub>	Operating temperature	-40	+85	°C
T <sub>stg</sub>	Storage temperature	-65	+150	°C
VBAT	Supply Voltage	-0.3	4.5	V
VPWR	Charger Voltage	-0.3	6	V
V <sub>3.0IO</sub>	3.0V IO Input Voltage (IOVDD)	-0.3	3.6	V

Note : The chip can be damaged by any stress in excess of the absolute maximum ratings listed below.

### 2.2 PMU Characteristics

Table 2-2

Symbol	Parameter	Min	Typ	Max	Unit	Test Conditions
VBAT	Voltage Input	2.2	3.7	4.4	V	
VPWR	Charger supply Voltage	4.5	5.0	5.5	V	
Normal mode						
IOVDD	Voltage output	—	3.0	—	V	VBAT = 4.2V, 10mA loading
	Loading current	—	—	100	mA	IOVDD=3.0V@VBAT = 4.2V
BTVDD	Voltage output	—	1.25	—	V	IOVDD=3.0V, 10mA loading
	Loading current	—	—	60	mA	BTVDD=1.25V@IOVDD=3.0v
LP mode						
IOVDD	Loading current			5	mA	IOVDD=3V@VBAT = 4.2V

## 2.3 Battery Charge

Table 2-3

Symbol	Parameter	Min	Typ	Max	Unit	Test Conditions
VPWR	Charge Input Voltage	4.5	5	5.5	V	—
V <sub>Charge</sub>	Charge Voltage	4.15	4.2	4.25	V	VPWR>4.5V
		4.30	4.35	4.40	V	VPWR>4.65V
I <sub>Charge</sub>	Charge Current	20		200	mA	Charge current at fast charge mode
I <sub>Trikl</sub>	Trickle Charge Current	20	45	70	mA	V <sub>BAT</sub> <V <sub>Trikl</sub>

## 2.4 IO Input/Output Electrical Logical Characteristics

Table 2-4

IO input characteristics						
Symbol	Parameter	Min	Typ	Max	Unit	Test Conditions
V <sub>IL</sub>	Low-Level Input Voltage	-0.3	—	0.3* IOVDD	V	IOVDD = 3.0V
V <sub>IH</sub>	High-Level Input Voltage	0.7* IOVDD	—	IOVDD+0.3	V	IOVDD= 3.0V
IO output characteristics						
V <sub>OL</sub>	Low-Level Output Voltage	—	—	0.33	V	IOVDD= 3.0V
V <sub>OH</sub>	High-Level Output Voltage	2.7	—	—	V	IOVDD = 3.0V

## 2.5 Internal Resistor Characteristics

Table 2-5

Port	Drive(mA)				Internal Pull-Up Resistor	Internal Pull-Down Resistor	Comment
PA1 PA2 PB1 PB2 PB6 PB8	2.4	8	26.4	64	10K	10K	1、PB1 default pull up 2、USBDM & USBDP default pull Down
PP0(VPWR), P00	8				10K	10K	3、PP0(VPWR), P00 are high voltage resistance to 5V
USBDP	4				1.5K	15K	4、internal pull-up/pull-down resistance   accuracy ±20%
USBDM	4				180K	15K	

### Confidential

The information contained herein is the exclusive property of JIELI and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of JIELI.



## 2.6 DAC Characteristics

Table 2-6

Parameter	Min	Typ	Max	Unit	Audio Format	Test Conditions
Frequency Response	20	—	20K	Hz	—	Differential Mode 1KHz/0dB 32 ohm loading With A-Weighted Filter
Output Swing		0.56	0.72	V <sub>rms</sub>		
THD+N	—	-78	—	dB	PCM	
	—	-69.6	—	dB	SBC	
S/N	—	100	102	dB	PCM	
	—	99.5	—	dB	SBC	
Dynamic Range	—	100.2	—	dB	PCM	Differential Mode 1KHz/-60dB 32 ohm loading With A-Weighted Filter
	—	100	—	dB	SBC	
Noise Floor		5.9		uV	—	A-Weighted Filter
DAC Output Power	—	9.7	16.0	mW	—	Differential Mode 32ohm loading

## 2.7 ADC Characteristics

Table 2-7

Parameter	Min	Typ	Max	Unit	Test Conditions
Dynamic Range		95		dB	F <sub>sample</sub> =44.1kHz F <sub>in</sub> =1KHz 2mV <sub>pp</sub> Input
S/N	—	95	—	dB	F <sub>sample</sub> =44.1kHz F <sub>in</sub> =1KHz 2V <sub>pp</sub> Input
THD+N	—	-72	—	dB	
Crosstalk	—	-80	—	dB	

## 2.8 BT Characteristics

### 2.8.1 Transmitter

Basic Data Rate

Table 2-8

Parameter	Min	Typ	Max	Unit	Test Conditions
RF Transmit Power		8.2	10	dBm	25℃, Power Supply VBAT=3.7V
RF Power Control Range		18.0		dB	
20dB Bandwidth		950		KHz	
Adjacent Channel	+2MHz	-40		dBm	

### Confidential

The information contained herein is the exclusive property of JIELI and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of JIELI.

	-2MHz		-38		dBm	
	+3MHz		-44		dBm	
	-3MHz		-35		dBm	

**Enhanced Data Rate****Table 2-9**

Parameter		Min	Typ	Max	Unit	Test Conditions
Relative Power			-1.2		dB	25°C, Power Supply VBAT=3.7V 2441MHz 2 Layer Board
$\pi/4$ DQPSK	DEVM RMS	6	10.9		%	
	DEVM 99%	10	19.0		%	
	DEVM Peak	15	24.3		%	
Modulation Accuracy	+2MHz		-40		dBm	
Adjacent Channel	-2MHz		-38		dBm	
Transmit Power	+3MHz		-44		dBm	
	-3MHz		-35		dBm	

## 2.8.2 Receiver

**Basic Data Rate****Table 2-10**

Parameter		Min	Typ	Max	Unit	Test Conditions
Sensitivity			-91		dBm	25°C, Power Supply
Co-channel Interference Rejection			-10		dB	
Adjacent Channel	+1MHz		+4		dB	VBAT=3.7V 2441MHz
	-1MHz		+2		dB	
	+2MHz		+38		dB	DH5 2 Layer Board
Interference Rejection	-2MHz		+38		dB	
	+3MHz		>+40		dB	
	-3MHz		+34		dB	

**Enhanced Data Rate****Table 2-11**

Parameter		Min	Typ	Max	Unit	Test Conditions
Sensitivity			-94		dBm	25°C, Power Supply
Co-channel Interference Rejection			-11		dB	
Adjacent Channel	+1MHz		+4		dB	VBAT=3.7V
Interference Rejection	-1MHz		+2		dB	

### Confidential

The information contained herein is the exclusive property of JIELI and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of JIELI.

	+2MHz		+38		dB	
	-2MHz		+38		dB	
	+3MHz		>+40		dB	
	-3MHz		+34		dB	

## 2.9 ESD Protection

**Table 2-12**

Parameter	Typ.	Test pin	Reference standard
Human Body Mode	± 4KV	All pins	JEDEC EIA/JESD22-A114
Machine Mode	± 200V	All pins	JEDEC EIA/JESD22-A115
Charge Device Model	± 1KV	All pins	JEDEC EIA/JESD22-C101F
Latch up	± 200mA	All GPIO pins	JEDEC STANDARD NO.78E
	1.5xVopmax	All power pins	

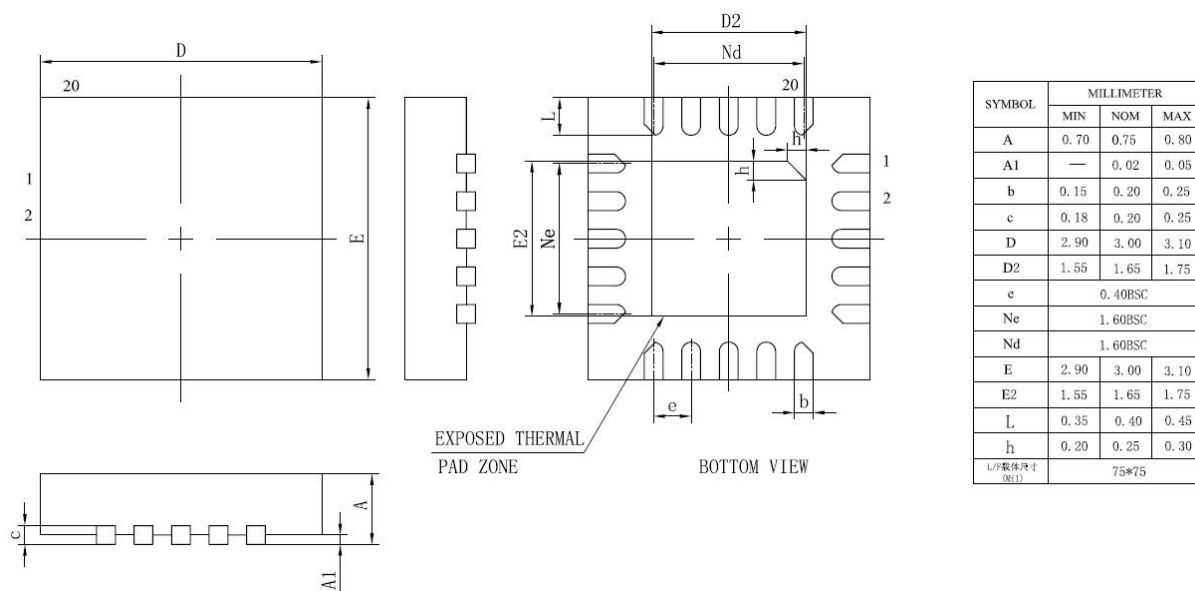
Note : 1.5xVopmax = 1.5 times maximum operating voltage.

### Confidential

The information contained herein is the exclusive property of JIELI and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of JIELI.

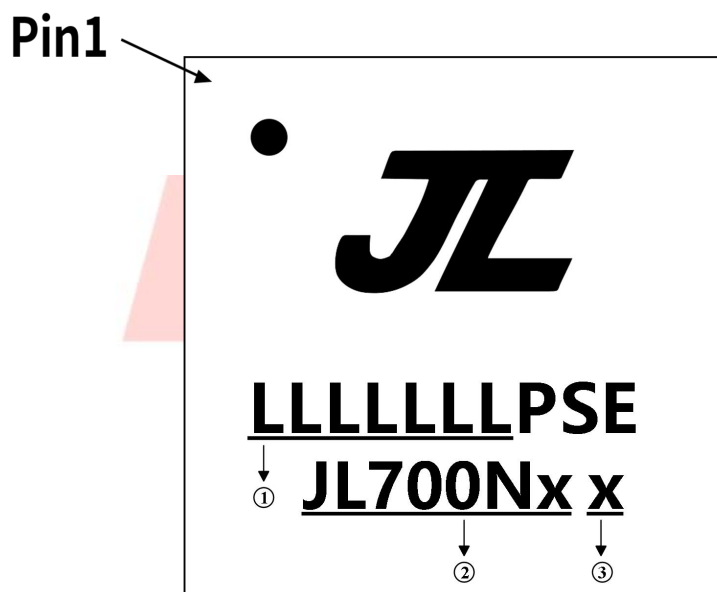
### 3 Package Information

#### 3.1 QFN20\_3.0x3.0



**Figure 3-1 JL7003A Package**

## 4 IC Marking Information



- ① LLLLLL: Production Batch
- ② JL700Nx: Chip Model
- ③ x: Built-in flash size
  - 0: No Flash Memory
  - 2: 2Mbit Flash
  - 4: 4Mbit Flash
  - 8: 8Mbit Flash
  - 6: 16Mbit Flash
  - 3: 32Mbit Flash

## 5 Solder-Reflow Condition

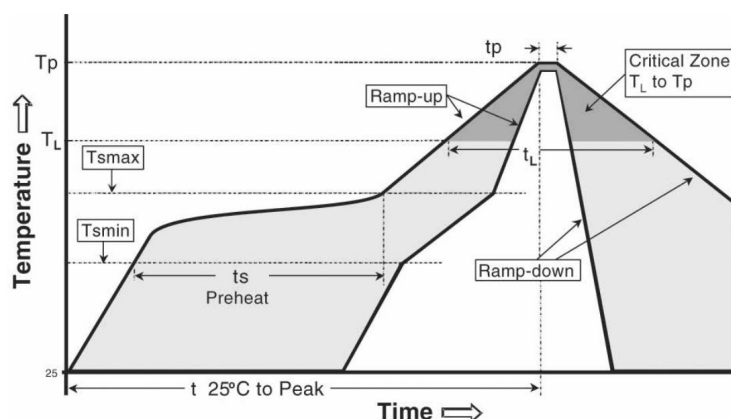


Figure 5-1 Classification Reflow Profile

Classification Profiles

Table 5-1

Profile Feature		Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat /Soak	Temperature Min ( $T_{smin}$ )	100°C	150°C
	Temperature Max ( $T_{smax}$ )	150°C	200°C
	Time ( $t_s$ ) from ( $T_{smin}$ to $T_{smax}$ )	60-120 seconds	60-180 seconds
Average ramp-up rate ( $T_{smax}$ to $T_p$ )		3°C/second max	3°C/second max
Liquidous temperature ( $T_L$ )		183°C	217°C
Time ( $t_L$ ) maintained above $T_L$		60-150 seconds	60-150 seconds
Peak package body temperature ( $T_p$ )		See Table 5-2	See Table 5-3
Time within 5°C of actual Peak Temperature ( $t_p$ ) <sup>2</sup>		10-30 seconds	20-40 seconds
Ramp-down rate ( $T_p$ to $T_L$ )		6°C/second max	6°C/second max
Time 25°C to peak temperature		6 minutes max	8 minutes max

Note 1: All temperatures refer to topside of the package, measured on the package body surface.

Note 2: Time within 5°C of actual peak temperature ( $t_p$ ) specified for the reflow profiles is a “supplier” minimum and “user” maximum.

SnPb - Classification Temperature

Table 5-2

Package Thickness	Volume mm <sup>3</sup> < 350	Volume mm <sup>3</sup> ≥ 350
<2.5 mm	240 +0/-5°C	225 +0/-5°C
≥2.5 mm	225 +0/-5°C	225 +0/-5°C

**Pb-free - Classification Temperature****Table 5-3**

<b>Package Thickness</b>	<b>Volume mm<sup>3</sup> &lt; 350</b>	<b>Volume mm<sup>3</sup> 350 - 2000</b>	<b>Volume mm<sup>3</sup> &gt; 2000</b>
< 1.6mm	260°C	260°C	260°C
1.6 mm - 2.5mm	260°C	250°C	245°C
> 2.5mm	250°C	245°C	245°C

**Confidential**

The information contained herein is the exclusive property of JIELI and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of JIELI.

## 6 Revision History

Date	Revision	Description
2022.05.14	V1.0	Initial Release
2022.07.13	V1.1	Update Package Information & Soft-off mode current consumption

**Confidential**

The information contained herein is the exclusive property of JIELI and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of JIELI.